

### Chip Card & Security ICs

**SLE 5528** 

Intelligent 1024 Byte EEPROM with Write Protection and Programmable Security Code

SLE 5528 Short Product Information				
Revision History:		Current Version 2007-05-02		
Previous Releases: 2006-11-24				
Page	Subjects (changes since last revision)			
	Preliminary removed, editorial updates			

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#### To our valued customers

We constantly strive to improve the quality of all our products and documentation. We have spent an exceptional amount of time to ensure that this document is correct. However, we realise that we may have missed a few things. If you find any information that is missing or appears in error, please use the contact section above to inform us. We appreciate your assistance in making this a better document.

#### Attention please!

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#### Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office in Germany or our Infineon Technologies Representatives world-wide (see address list).

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## Intelligent 1024 Byte EEPROM with Write Protection and Programmable Security Code (PSC)

# M3

#### **Features**

- 100% functional compatibility to SLE 4428
- 1024 x 8 bit EEPROM organization of Data Memory
- 1024 x 1 bit Protection Memory
  - Byte-wise write protection of Data Memory (one time programmable)
  - Not alterable Manufacturer Code (chip coding and unique coding by application identifier RID according to ISO/IEC 7816-5)
- Data Memory alterable only after verification of 2 Byte PSC
- PSC verification trials limited by Error Counter
- Serial synchronous three-wire link protocol according to ISO/IEC 7816
  - Byte-wise addressing
  - End of processing indicated at data output
- Contact configuration and Answer-to-Reset (synchronous transmission) in accordance to standard ISO/IEC 7816
- Electrical characteristics
  - Ambient temperature range -40 ... +100°C for chip, -25 ... +80°C for module
  - Supply voltage 5V ± 10%
  - Supply current < 1 mA</li>
  - EEPROM erase / write time 5 ms / 5 ms
  - ESD protection typically 4,000 V
  - EEPROM Endurance minimum 100,000 erase / write cycles<sup>1)</sup>
  - Data retention for minimum of 10 years<sup>1)</sup>
- Advanced CMOS-technology optimized for security layout
  - EEPROM-cells protected by shield
  - Shielding of deeper layers via metal
  - Sensory- and logical security functions
  - No insulation of backside necessary

Short Product Information

<sup>1)</sup> Values are temperature dependent.



#### 1 Ordering and Packaging information

Table 1 Ordering Information

Туре	Package <sup>1)</sup>	Remark	Ordering Code
SLE 5528 C	Die (on Wafer)	not sawn	on request
SLE 5528 D	Die (on Wafer)	Sawn	on request
SLE 5528 M3	T-M3.2-6		on request
SLE 5528 MFC3	S-MFC3.1-6-1	FCoS™	on request

#### **Pin Description**

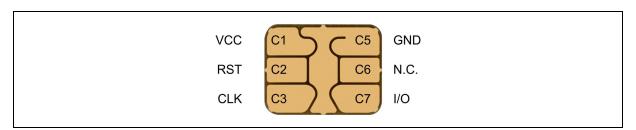


Figure 1 Pin Configuration Wire-bonded Module M3.2 (top view)

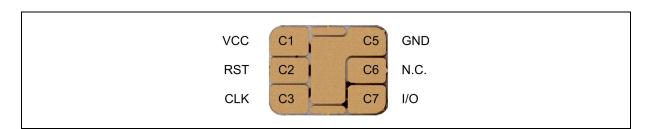


Figure 2 Pin Configuration Module Flip Chip MFC3.1 (top view)

**Short Product Information** 

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<sup>1)</sup> Available as a Module Flip Chip (MFC3), wire-bonded module (M2 and M3) for embedding in plastic cards or as a die on non-sawn (C) / sawn wafer (D) for customer packaging





Figure 1 Pad Configuration Die

Table 2 Pin Definitions and Functions M3 / MFC3

Card Contact	Symbol	Function
C1	VCC	Supply voltage
C2	RST	Reset (Chip Enable)
C3	CLK	Clock input
C5	GND	Ground
C6	N.C.	Not connected
C7	I/O	Bi-directional data line (open drain)



#### 2 Circuit Description

#### Memory Organization

The memory is organized in a **Data Memory** of 1024 byte.

#### Write Protection of Data Memory

**Write Protection Bits**: Each byte of the Data Memory can be irreversibly protected against data change by writing the corresponding bit in the **Write Protection Memory**. Dependent on the state of the protection bit the Data Memory is read only (ROM) or may be erased and written again (EEPROM). The manufacturer code (Application ID and Chip Coding) is programmed unalterable by the chip manufacturer.

#### Programmable Security Code

Altering data in the Data Memory as well as setting a Write Protection Bit is only possible after verification of the 2-Byte **Programmable Security Code (PSC)**.

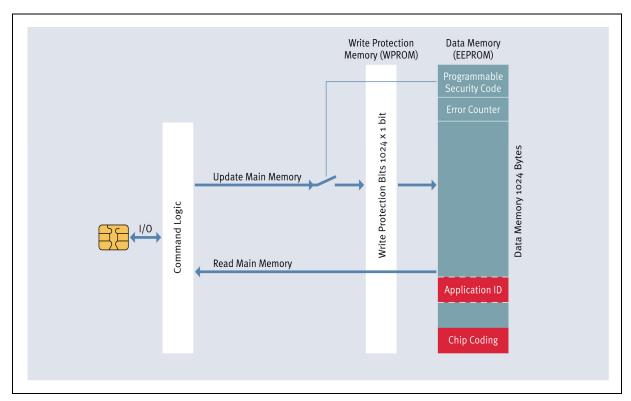


Figure 2 Memory Configuration SLE 5528